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Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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AA4040SF4S-P22

4.0 x 4.0 mm Infrared Emitting Diode



DESCRIPTION

 SF4 Made with Gallium Aluminum Arsenide Infrared Emitting diodes

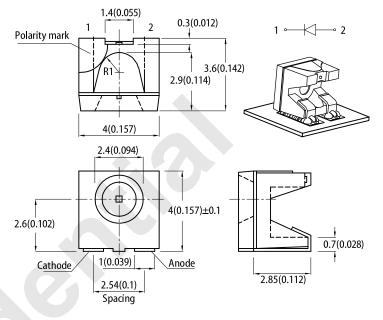
FEATURES

- · Suitable for all SMD assembly and solder process
- · Mechanically and spectrally matched to the phototransistor
- · Available on tape and reel
- Moisture sensitivity level: 3
- Package: 500 pcs / reel
- · RoHS compliant

APPLICATIONS

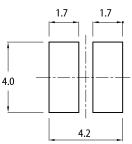
- Infrared Illumination for cameras
- Machine vision systems
- · Surveillance systems
- Industrial electronics
- IR data transmission
- Remote control

PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Notes

All dimensions are in millimeters (inches).
 Tolerance is ±0.25(0.01") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to

change without prior notice. 4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color	Lens Type	Po (mW/sr) @ 20mA ^[2]		Viewing Angle ^[1]	
	(Material)		Min.	Тур.	201/2	
AA4040SF4S-P22	Infrared (GaAIAs)	Water Clear	1.2	2.5	120°	

Notes

All 2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 Radiant Intensity / luminous flux: +/-15%.
 Radiant intensity value is traceable to CIE127-2007 standards.

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ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		l la it
Parameter			Тур.	Max.	Unit
Wavelength at Peak Emission I_F = 20mA	λ_{peak}	Infrared	880	-	nm
Spectral Bandwidth at 50% Φ REL MAX I_{F} = 20mA	Δλ	Infrared	50	-	nm
Capacitance	С	Infrared	90	-	pF
Forward Voltage I_F = 20mA	V _F ^[1]	Infrared	1.3	1.6	V
Reverse Current (V _R = 5V)	I _R	Infrared	-	10	uA
Temperature Coefficient of Wavelength I_F = 20mA, -10°C $\leq T \leq 85^\circ C$	TC _λ	Infrared	0.3	-	nm/°C
Temperature Coefficient of $~V_F$ I_F = 20mA, -10° $C \leq T \leq 85^\circ C$	TCv	Infrared	-1.3	-	mV/°C

Notes:

Forward voltage: ±0.1V.
 Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

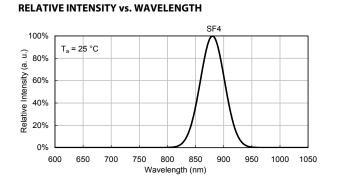
Parameter	Symbol	Value	Unit
Power Dissipation	P _D	85	mW
Reverse Voltage	V _R	5	V
Junction Temperature	Tj	125	°C
Operating Temperature	T _{op}	-40 to +85	°C
Storage Temperature	T _{stg}	-40 to +85	°C
DC Forward Current	١ _F	50	mA
Peak Forward Current	I _{FM} ^[1]	1200	mA
Electrostatic Discharge Threshold (HBM)	-	8000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	250	°C/W
Thermal Resistance (Junction / Solder point)	$R_{thJS}^{[2]}$	135	°C/W

Notes:

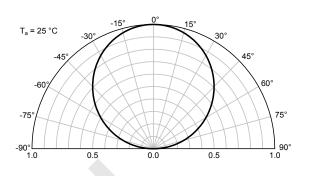
Notes: 1. //100 Duty Cycle, 10µs Pulse Width. 2. R_{th JA} ,R_{th JS} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

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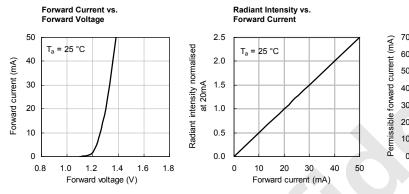
TECHNICAL DATA

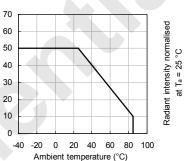


SPATIAL DISTRIBUTION



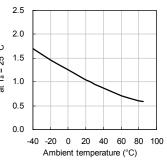
INFRARED



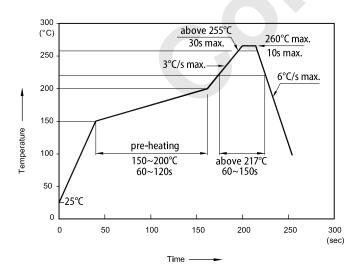


Forward Current Derating Curve

Radiant Intensity vs. Ambient Temperature



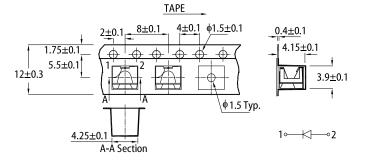
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



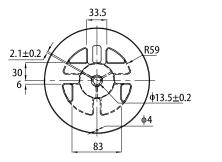
Notes 1. Don't cause stress to the LEDs while it is exposed to high temperature.

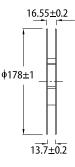
- The maximum number of reflow soldering passes is 2 times.
 Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

TAPE SPECIFICATIONS (units : mm)



REEL DIMENSION (units : mm)

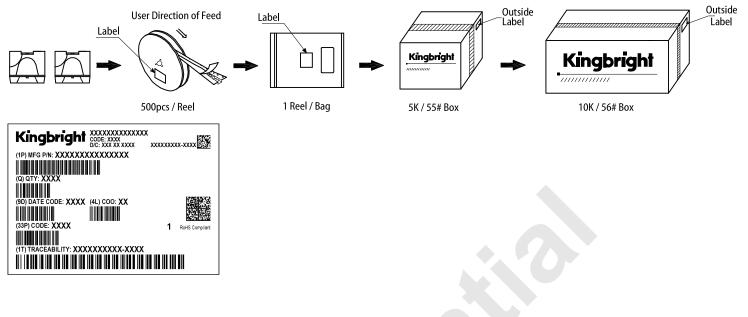




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AA4040SF4S-P22

PACKING & LABEL SPECIFICATIONS



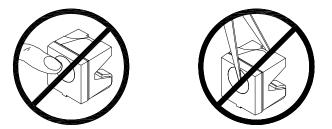
HANDLING PRECAUTIONS

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



3. As silicone encapsulation is permeable to gases, some corrosive substances such as H₂S might corrode silver plating of lead frame. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications. 2
- 3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits. Kingbright will not be responsible for any subsequent issues. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
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- 6 All design applications should refer to Kingbright application notes available at http://www